# **Low Capacitance Quad Array for ESD Protection**

This integrated transient voltage suppressor device (TVS) is designed for applications requiring transient overvoltage protection. It is intended for use in sensitive equipment such as computers, printers, business machines, communication systems, medical equipment, and other applications. Its integrated design provides very effective and reliable protection for four separate lines using only one package. These devices are ideal for situations where board space is at a premium.

#### **Features**

- ESD Protection: IEC61000-4-2: Level 4
  - MILSTD 883C Method 3015-6: Class 3
- Four Separate Unidirectional Configurations for Protection
- Low Leakage Current < 1 μA</li>
- Power Dissipation: 380 mW
- Small SC–88A SMT Package
- Low Capacitance
- Pb-Free Package is Available

- Provides Protection for ESD Industry Standards: IEC 61000, HBM
- Protects the Line Against Transient Voltage Conditions in Either
- Minimize Power Consumption of the System WWW.DZSC.COM
- Minimize PCB Board Space

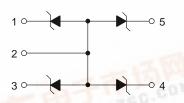
#### **Typical Applications**

- Instrumentation Equipment
- Serial and Parallel Ports
- Microprocessor Based Equipment
- Notebooks, Desktops, Servers
- Cellular and Portable Equipment



# ON Semiconductor®

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SC-88A/SOT-323 **CASE 419A** 

## MARKING DIAGRAM



- = H for NSQA6V8AW5T2 X for NSQA12VAW5T2
- = One Digit Date Code

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
NSQA6V8AW5T2	SC-88A	3000/Tape & Reel
NSQA6V8AW5T20	SC-88A (Pb-Free)	3000/Tape & Reel
NSQA12VAW5T2	SC-88A	3000/Tape & Reel
NSQA12VAW5T20	SC-88A (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



# **MAXIMUM RATINGS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Power Dissipation $8 \times 20~\mu sec$ Double Exponential Waveform (Note 1)	P <sub>PK</sub>	20	W
Steady State Power – 1 Diode (Note 2)	$P_{D}$	380	mW
Thermal Resistance – Junction–to–Ambient Above 25°C, Derate	$R_{ hetaJA}$	327 3.05	°C/W mW/°C
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Lead Solder Temperature – Maximum 10 Seconds Duration	TL	260	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

- 1. Non-repetitive current pulse per Figure 1.
- 2. Only 1 diode under power. For all 4 diodes under power, PD will be 25%. Mounted on FR4 board with min pad.

# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

## NSQA6V8AW5T2

Characteristic		Min	Тур	Max	Unit
Breakdown Voltage (I <sub>T</sub> = 1 mA) (Note 3)		6.4	6.8	7.1	V
Leakage Current (V <sub>RWM</sub> = 5.0 V)		-	-	1.0	μΑ
Clamping Voltage 1 (I <sub>PP</sub> = 1.6 A, 8 $\times$ 20 $\mu$ sec Waveform)		-	-	13	V
Maximum Peak Pulse Current (8 × 20 μsec Waveform)		-	-	1.6	Α
			12 6.7	15 9.5	pF

## NSQA12VAW5T2

Breakdown Voltage (I <sub>T</sub> = 5 mA) (Note 3)	$V_{BR}$	11.4	12.0	12.7	V
Leakage Current (V <sub>RWM</sub> = 9.0 V)	I <sub>R</sub>	-	-	0.05	μΑ
Zener Impedence (I <sub>T</sub> = 5 mA)	Z <sub>Z</sub>	-	-	30	Ω
Clamping Voltage 1 ( $I_{PP}$ = 0.9 A, 8 $\times$ 20 $\mu$ sec Waveform)	V <sub>C</sub>	-	-	23	V
Maximum Peak Pulse Current (8 × 20 μsec Waveform)	I <sub>PP</sub>	-	_	0.9	Α
Junction Capacitance – (V <sub>R</sub> = 0 V, f = 1 MHz)	CJ	_	_	15	pF

<sup>3.</sup>  $V_{BR}$  is measured at pulse test current  $I_{T}$ .

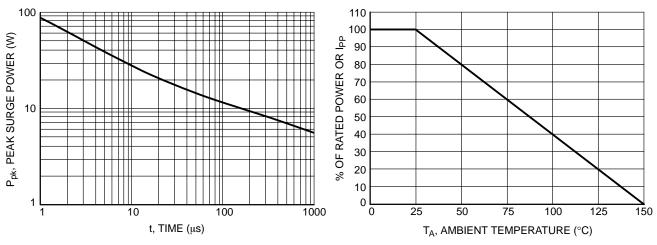


Figure 1. Pulse Width

Figure 2. Power Derating Curve

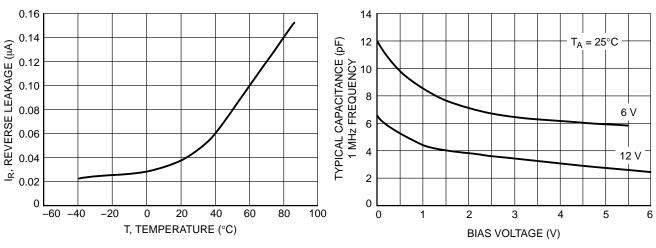


Figure 3. Reverse Leakage versus Temperature

Figure 4. Capacitance

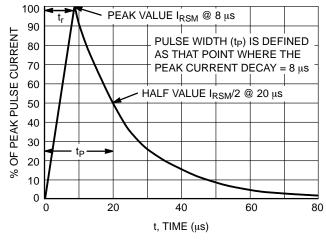


Figure 5.  $8\times 20~\mu s$  Pulse Waveform

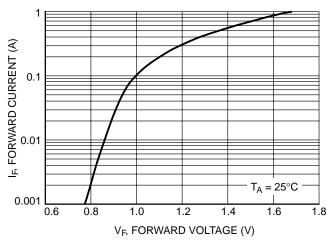
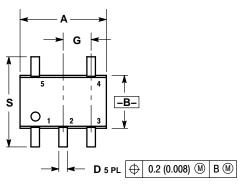


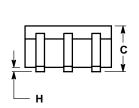
Figure 6. Forward Voltage

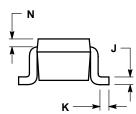
#### PACKAGE DIMENSIONS

#### SC-88A/SOT-323

5-LEAD PACKAGE CASE 419A-02 ISSUE G





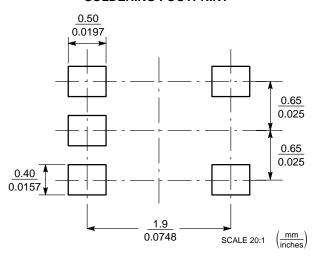


#### NOTES:

- DIMENSIONING AND TOLERANCING
   PER ANSI Y14 5M 1982
- PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.
- 3. 419A-01 OBSOLETE. NEW STANDARD 419A-02.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	INCHES		MILLIM	ETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.071	0.087	1.80	2.20	
В	0.045	0.053	1.15	1.35	
С	0.031	0.043	0.80	1.10	
D	0.004	0.012	0.10	0.30	
G	0.026 BSC		0.65 BSC		
Н		0.004		0.10	
J	0.004	0.010	0.10	0.25	
K	0.004	0.012	0.10	0.30	
N	0.008 REF		0.20 REF		
S	0.079	0.087	2.00	2.20	

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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